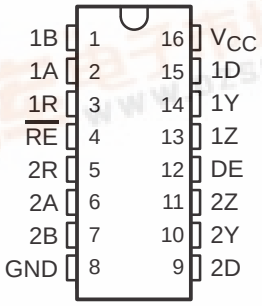
SN65C1167, SN75C1167, SN65C1168, SN75C1168
DUAL DIFFERENTIAL DRIVERS AND RECEIVERS

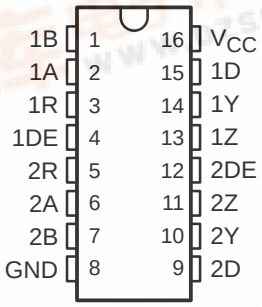
SLLS159E − MARCH 1993 − REVISED NOVEMBER 2003

- Meet or Exceed Standards TIA/EIA-422-B and ITU Recommendation V.11
- BiCMOS Process Technology
- Low Supply-Current Requirements: 9 mA Max
- Low Pulse Skew
- Receiver Input Impedance . . . 17 kΩ Typ
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Common-Mode Input Voltage Range of −7 V to 7 V
- Operate From Single 5-V Power Supply
- Glitch-Free Power-Up/Power-Down Protection
- Receiver 3-State Outputs Active-Low Enable for SN65C1167 and SN75C1167 Only
- Improved Replacements for the MC34050 and MC34051

SN65C1167 . . . DB OR NS PACKAGE
SN75C1167 . . . DB, N, OR NS PACKAGE
(TOP VIEW)



SN65C1168 . . . N, NS, OR PW PACKAGE
SN75C1168 . . . DB, N, NS, OR PW PACKAGE
(TOP VIEW)



description/ordering information

The SN65C1167, SN75C1167, SN65C1168, and SN75C1168 dual drivers and receivers are integrated circuits designed for balanced transmission lines. The devices meet TIA/EIA-422-B and ITU recommendation V.11.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP (N)	Tube	SN75C1167N	SN75C1167N
	SOP (NS)	Tape and reel	SN75C1167NSR	75C1167
	SSOP (DB)	Tape and reel	SN75C1167DBR	CA1167
	PDIP (N)	Tube	SN75C1168N	SN75C1168N
	SOP (NS)	Tape and reel	SN75C1168NSR	75C1168
	SSOP (DB)	Tape and reel	SN75C1168DBR	CA1168
	TSSOP (PW)	Tube	SN75C1168PW	CA1168
		Tape and reel	SN75C1168PWR	
−40°C to 85°C	SOP (NS)	Tape and reel	SN65C1167NSR	65C1167
	SSOP (DB)	Tape and reel	SN65C1167DBR	CB1167
	PDIP (N)	Tube	SN65C1168N	SN65C1168N
	SOP (NS)	Tape and reel	SN65C1168NSR	65C1168
	TSSOP (PW)	Tube	SN65C1168PW	CB1168
		Tape and reel	SN65C1168PWR	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

description/ordering information (continued)

The SN65C1167 and SN75C1167 combine dual 3-state differential line drivers and 3-state differential line receivers, both of which operate from a single 5-V power supply. The driver and receiver have active-high and active-low enables, respectively, which can be connected together externally to function as direction control. The SN65C1168 and SN75C1168 drivers have individual active-high enables.

Function Tables

EACH DRIVER

INPUT D	ENABLE DE	OUTPUTS	
		Y	Z
H	H	H	L
L	H	L	H
X	L	Z	Z

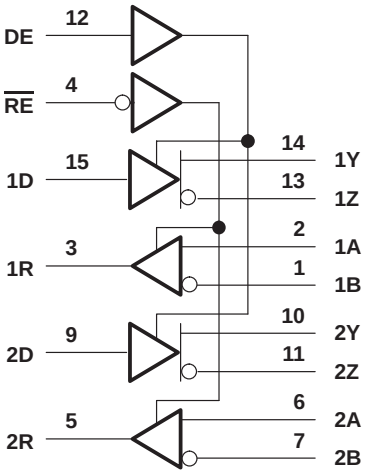
SN75C1167, EACH RECEIVER

DIFFERENTIAL INPUTS A − B	ENABLE $\overline{RE}$	OUTPUT R
$V_{ID} \geq 0.2$ V	L	H
-0.2 V $< V_{ID} < 0.2$ V	L	?
$V_{ID} \leq -0.2$ V	L	L
X	H	Z
Open	L	H

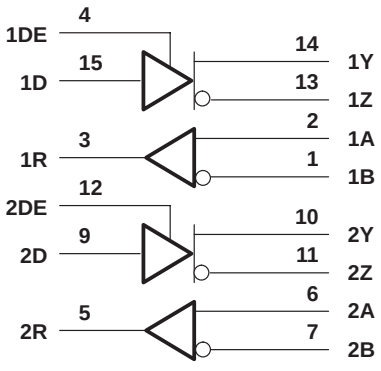
H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)

logic diagram (positive logic)

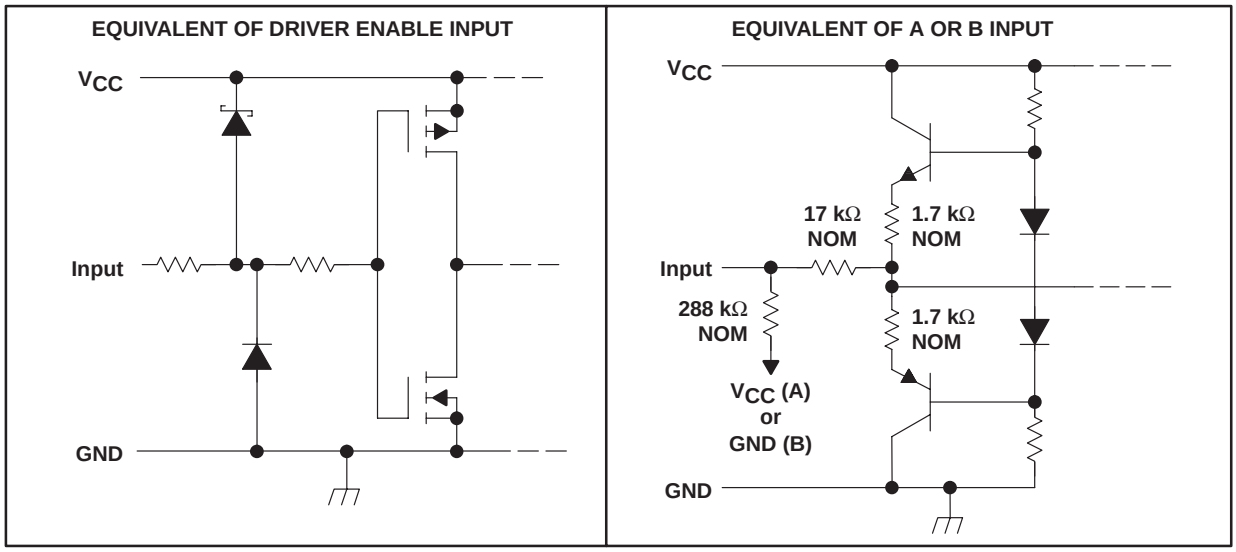
SN65C1167/SN75C1167



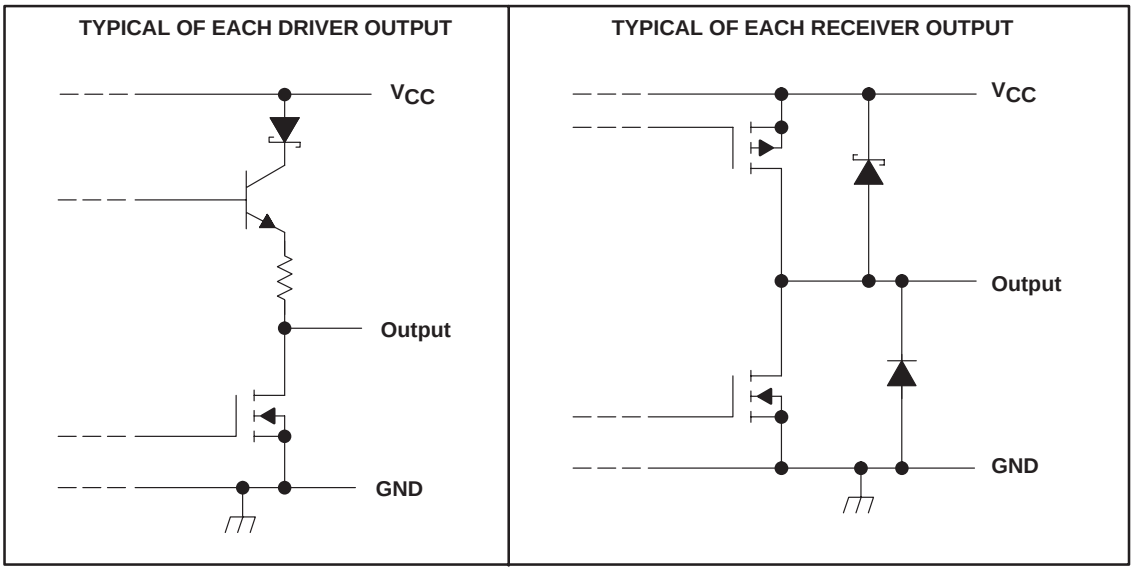
SN65C1168, SN75C1168



schematics of inputs



schematics of outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1) . . . . . −0.5 V to 7 V
Input voltage range, V_I . . . . . −0.5 V to V_{CC} + 0.5 V
Input voltage range, V_I (A or B, Receiver) . . . . . −11 V to 14 V
Differential input voltage range, V_{ID}, Receiver (see Note 2) . . . . . −14 V to 14 V
Output voltage range, V_O, Driver . . . . . −5 V to 7 V
Clamp current range, I_{IK} or I_{OK}, Driver . . . . . ±20 mA
Output current range, I_O, Driver . . . . . ±150 mA
Supply current, I_{CC} . . . . . 200 mA
GND current . . . . . −200 mA
Output current range, I_O, Receiver . . . . . ±25 mA
Operating virtual junction temperature . . . . . 150°C
Package thermal impedance, θ_{JA} (see Notes 3 and 4): DB package . . . . . 82°C/W
N package . . . . . 67°C/W
NS package . . . . . 64°C/W
PW package . . . . . 108°C/W
Storage temperature range, T_{stg} . . . . . −65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values except differential input voltage are with respect to the network GND.
2. Differential input voltage is measured at the noninverting terminal with respect to the inverting terminal.
3. Maximum power dissipation is a function of $T_J(max)$, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Selecting the maximum of 150°C can affect reliability.
4. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

				MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage			4.5	5	5.5	V
V_{IC}	Common-mode input voltage (see Note 5)	Receiver				±7	V
V_{ID}	Differential input voltage	Receiver				±7	V
V_{IH}	High-level input voltage	Except A, B		2			V
V_{IL}	Low-level input voltage	Except A, B				0.8	V
I_{OH}	High-level output current	Receiver				−6	mA
		Driver				−20	
I_{OL}	Low-level output current	Receiver				6	mA
		Driver				20	
T_A	Operating free-air temperature		SN75C1167, SN75C1168	0		70	°C
			SN65C1167, SN65C1168	−40		85	

NOTE 5: Refer to TIA/EIA-422-B for exact conditions.

DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IK}	Input clamp voltage	I_I = −18 mA				−1.5	V
V_{OH}	High-level output voltage	V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −20 mA		2.4	3.4		V
V_{OL}	Low-level output voltage	V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 20 mA			0.2	0.4	V
$\|V_{OD1}\|$	Differential output voltage	I_O = 0 mA		2		6	V
$\|V_{OD2}\|$	Differential output voltage	R_L = 100 Ω, See Figure 1 and Note 5		2	3.1		V
$\Delta\|V_{OD}\|$	Change in magnitude of differential output voltage					±0.4	V
V_{OC}	Common-mode output voltage					±3	V
$\Delta\|V_{OC}\|$	Change in magnitude of common-mode output voltage					±0.4	V
$I_{O(OFF)}$	Output current with power off (see Note 3)	V_{CC} = 0 V	V_O = 6 V			100	µA
			V_O = −0.25 V			−100	µA
I_{OZ}	High-impedance-state output current	V_O = 2.5 V				20	µA
		V_O = 5 V				−20	
I_{IH}	High-level input current	$V_I = V_{CC}$ or V_{IH}				1	µA
I_{IL}	Low-level input current	V_I = GND or V_{IL}				−1	µA
I_{OS}	Short-circuit output current	$V_O = V_{CC}$ or GND, See Note 6		−30		−150	mA
I_{CC}	Supply current (total package)	No load, Enabled	$V_I = V_{CC}$ or GND		4	6	mA
			V_I = 2.4 or 0.5 V, See Note 7		5	9	
C_i	Input capacitance				6		pF

† All typical values are at V_{CC} = 5 V and T_A = 25°C.

NOTES: 5. Refer to TIA/EIA-422-B for exact conditions.
6. Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.
7. This parameter is measured per input, while the other inputs are at V_{CC} or GND.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t_{PHL}	Propagation delay time, high- to low-level output	$R_1 = R_2 = 50\ \Omega$, $R_3 = 500\ \Omega$, $C_1 = C_2 = C_3 = 40$ pF, S1 is open, See Figure 2		7	12	ns
t_{PLH}	Propagation delay time, low- to high-level output			7	12	ns
$t_{sk(p)}$	Pulse skew			0.5	4	ns
t_r	Rise time	$R_1 = R_2 = 50\ \Omega$, $R_3 = 500\ \Omega$, $C_1 = C_2 = C_3 = 40$ pF, S1 is open, See Figure 3		5	10	ns
t_f	Fall time			5	10	ns
t_{PZH}	Output enable time to high level	$R_1 = R_2 = 50\ \Omega$, $R_3 = 500\ \Omega$, $C_1 = C_2 = C_3 = 40$ pF, S1 is closed, See Figure 4		10	19	ns
t_{PZL}	Output enable time to low level			10	19	ns
t_{PHZ}	Output disable time from low level	$R_1 = R_2 = 50\ \Omega$, $R_3 = 500\ \Omega$, $C_1 = C_2 = C_3 = 40$ pF, S1 is closed, See Figure 4		7	16	ns
t_{PLZ}	Output disable time from high level			7	16	ns

† All typical values are at V_{CC} = 5 V and T_A = 25°C.

RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

PARAMETER			TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IT+}	Positive-going input threshold voltage, differential input						0.2	V
V_{IT-}	Negative-going input threshold voltage, differential input				−0.2‡			V
V_{hys}	Input hysteresis ($V_{IT+} - V_{IT-}$)					60		mV
V_{IK}	Input clamp voltage, $\overline{RE}$	SN75C1167	I_I = −18 mA				−1.5	V
V_{OH}	High-level output voltage		V_{ID} = 200 mV,	I_{OH} = −6 mA	3.8	4.2		V
V_{OL}	Low-level output voltage		V_{ID} = −200 mV,	I_{OL} = 6 mA		0.1	0.3	V
I_{OZ}	High-impedance-state output current	SN75C1167	V_O = V_{CC} or GND			±0.5	±5	µA
I_I	Line input current		Other input at 0 V	V_I = 10 V			1.5	mA
				V_I = −10 V			−2.5	
I_I	Enable input current, $\overline{RE}$	SN75C1167	V_I = V_{CC} or GND				±1	µA
r_i	Input resistance		V_{IC} = −7 V to 7 V,	Other input at 0 V	4	17		kΩ
I_{CC}	Supply current (total package)		No load, Enabled	V_I = V_{CC} or GND		4	6	mA
				V_{IH} = 2.4 V or 0.5 V, See Note 5		5	9	

† All typical values are at V_{CC} = 5 V and T_A = 25°C.
‡ The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.
NOTE 5: Refer to TIA/EIA-422-B for exact conditions.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 8)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	See Figure 5	9	17	27	ns
t_{PHL}	Propagation delay time, high- to low-level output		9	17	27	ns
t_{TLH}	Transition time, low- to high-level output	V_{IC} = 0 V, See Figure 5		4	9	ns
t_{THL}	Transition time, high- to low-level output			4	9	ns
t_{PZH}	Output enable time to high level	R_L = 1 kW, See Figure 6		13	22	ns
t_{PZL}	Output enable time to low level			13	22	ns
t_{PHZ}	Output disable time from high level			13	22	ns
t_{PLZ}	Output disable time from low level			13	22	ns

† All typical values are at V_{CC} = 5 V and T_A = 25°C.
NOTE 8: Measured per input while the other inputs are at V_{CC} or GND

PARAMETER MEASUREMENT INFORMATION

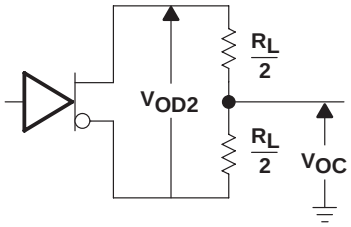
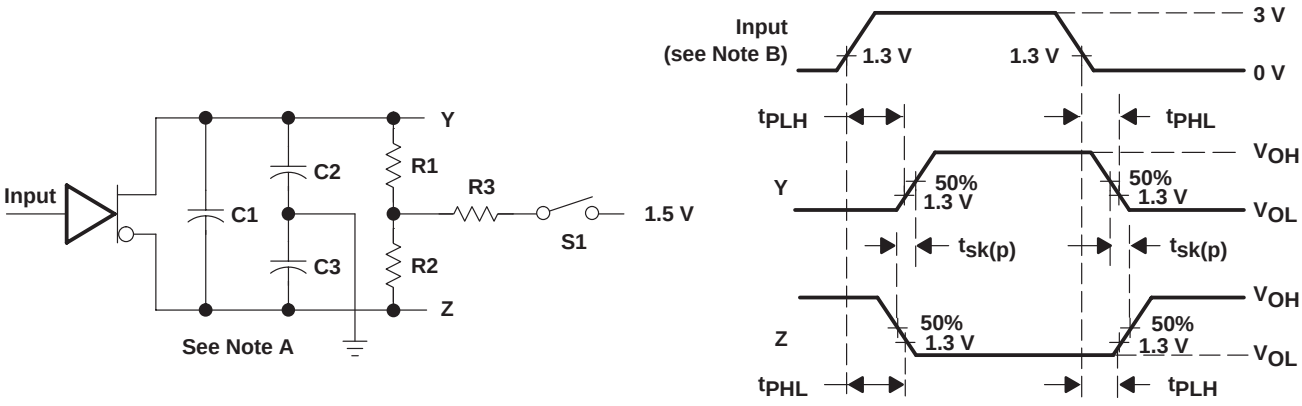


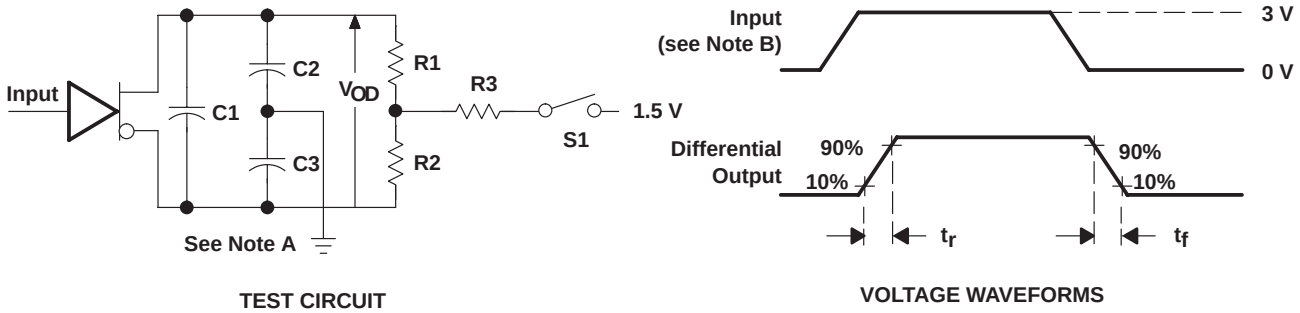
Figure 1. Driver Test Circuit, V_{OD} and V_{OC}



TEST CIRCUIT **VOLTAGE WAVEFORMS**

NOTES: A. C1, C2, and C3 include probe and jig capacitance.
B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_r = t_f \le 6$ ns.

Figure 2. Driver Test Circuit and Voltage Waveforms

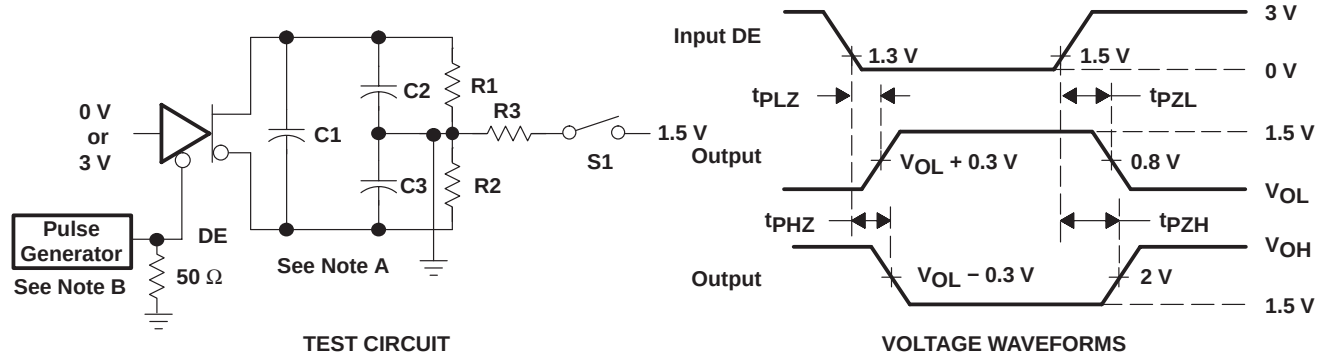


TEST CIRCUIT **VOLTAGE WAVEFORMS**

NOTES: A. C1, C2, and C3 include probe and jig capacitance.
B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_r = t_f \le 6$ ns.

Figure 3. Driver Test Circuit and Voltage Waveforms

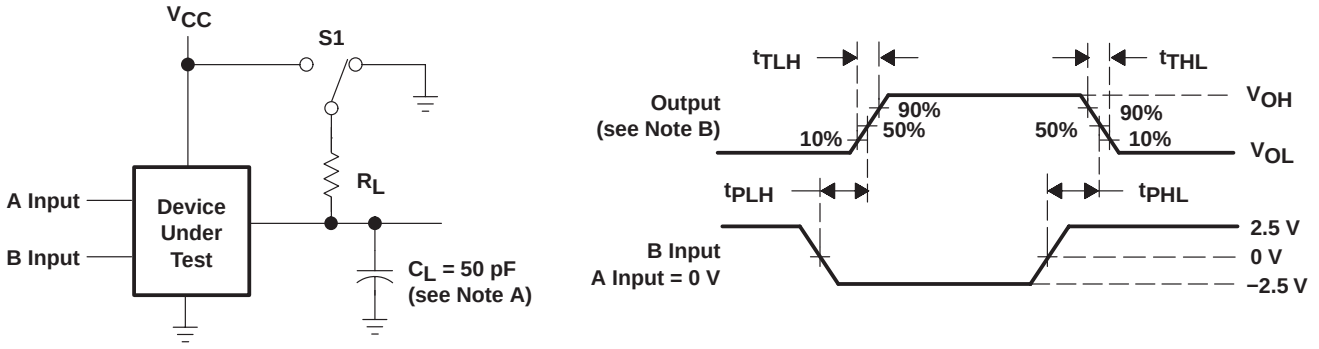
PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT **VOLTAGE WAVEFORMS**

NOTES: A. C1, C2, and C3 include probe and jig capacitance.
B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_r = t_f \le 6$ ns.

Figure 4. Driver Test Circuit and Voltage Waveforms

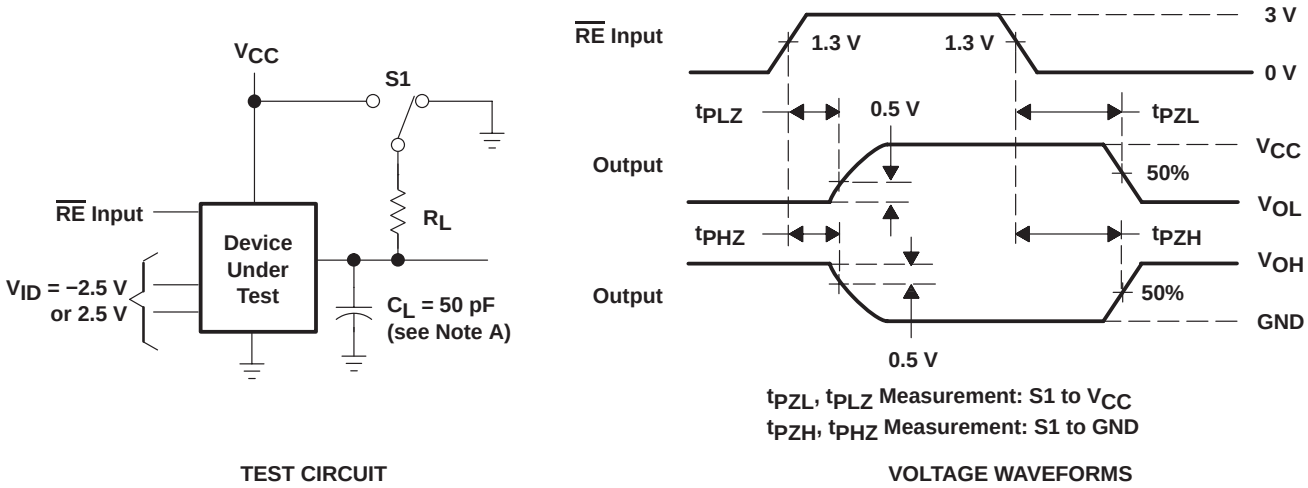


TEST CIRCUIT **VOLTAGE WAVEFORMS**

NOTES: A. C_L includes probe and jig capacitance.
B. The pulse generator has the following characteristics: PRR ≤ 1 MHz, duty cycle = 50%, $t_r = t_f \le 6$ ns.

Figure 5. Receiver Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT **VOLTAGE WAVEFORMS**

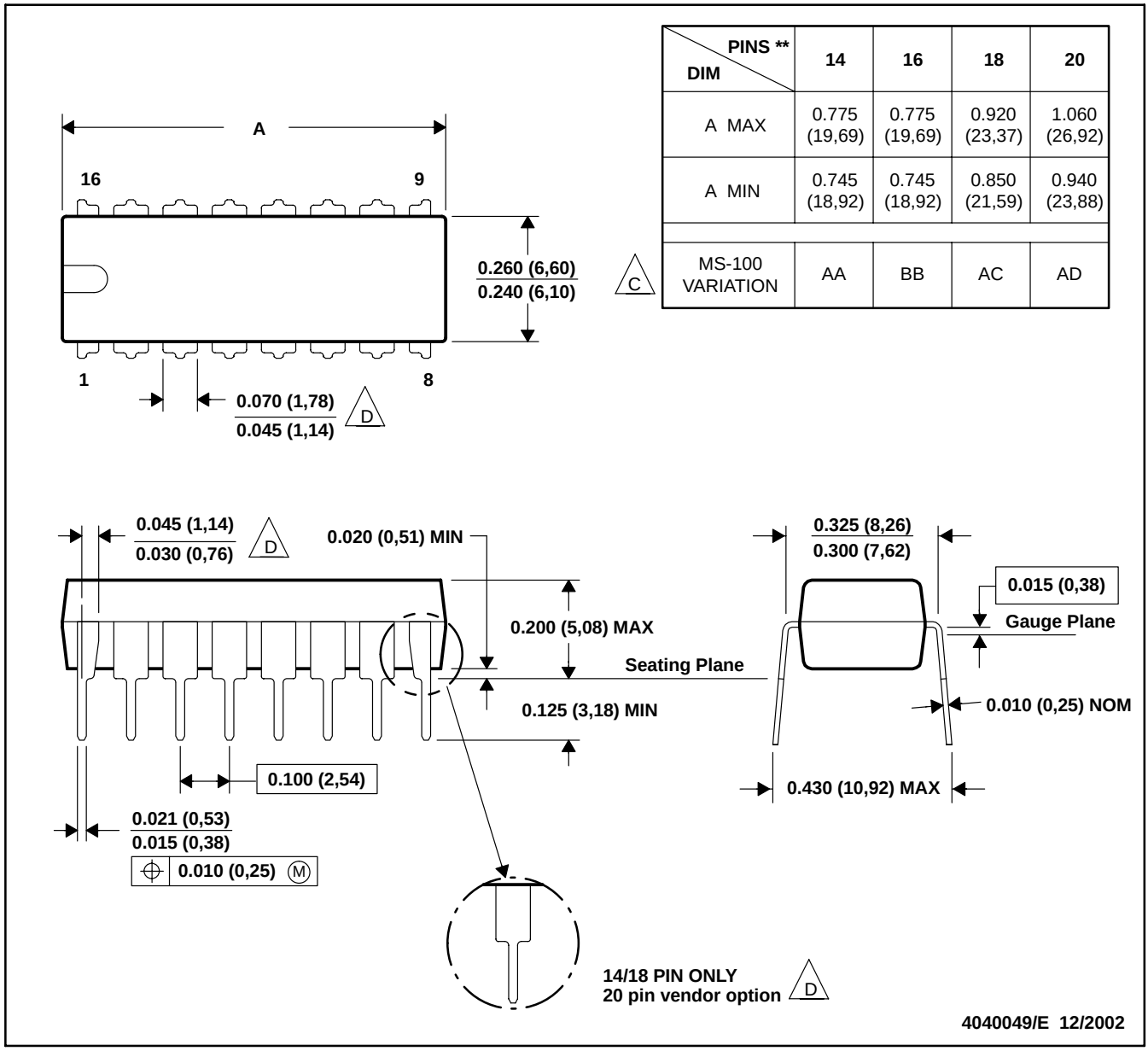
NOTES: A. C_L includes probe and jig capacitance.
B. The pulse generator has the following characteristics: PRR ≤ 1 MHz, duty cycle = 50%, $t_r = t_f \leq 6$ ns.

Figure 6. Receiver Test Circuit and Voltage Waveforms

MECHANICAL

N (R-PDIP-T)** **PLASTIC DUAL-IN-LINE PACKAGE**

16 PINS SHOWN



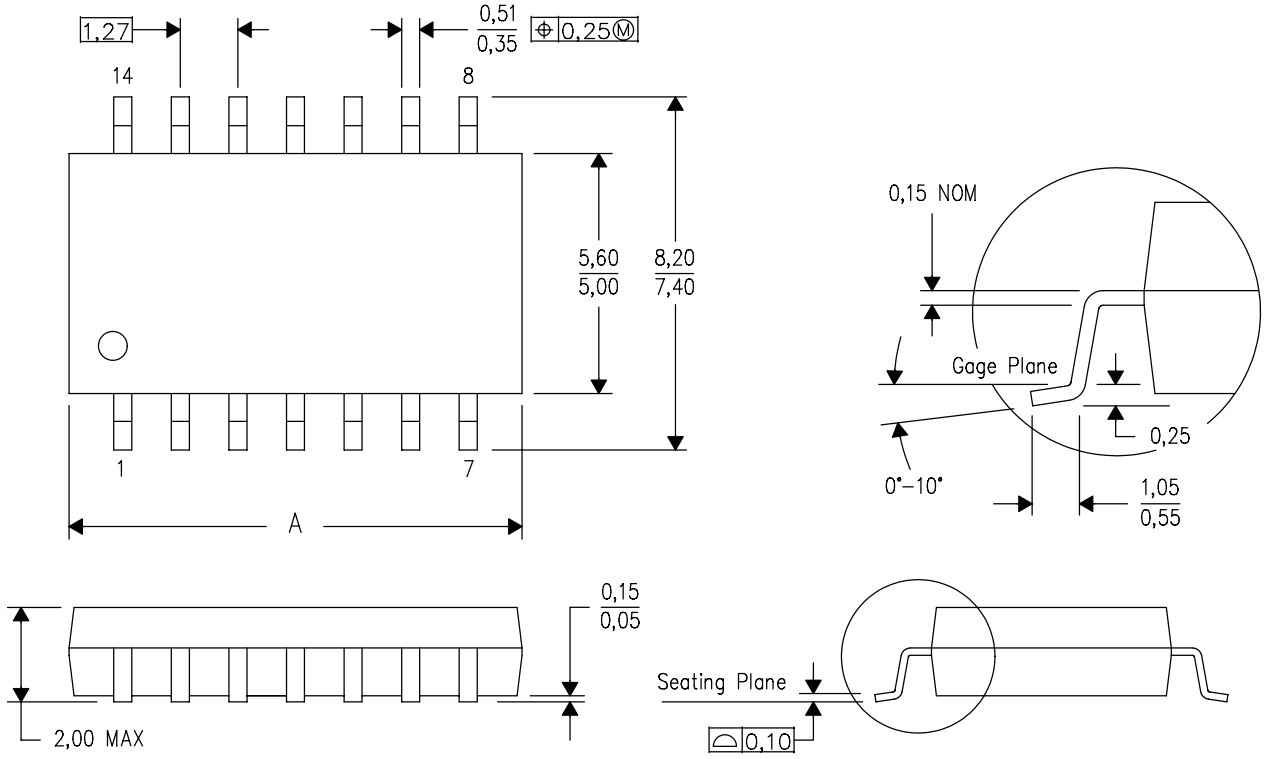
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-100 VARIATION	AA	BB	AC	AD

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body lrngth (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

MECHANICAL DATA

NS (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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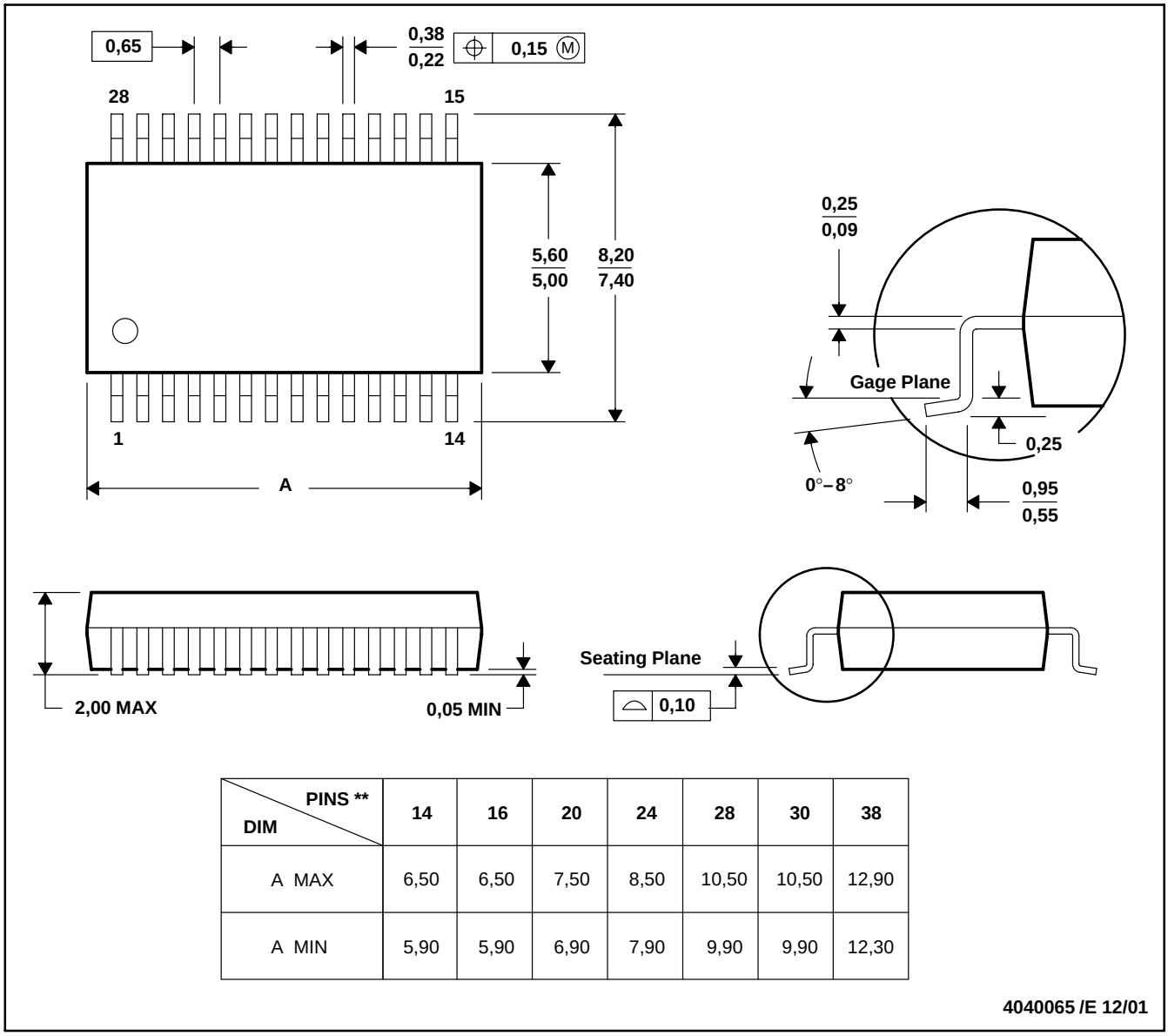
DB (R-PDSO-G)** **PLASTIC SMALL-OUTLINE**

28 PINS SHOWN



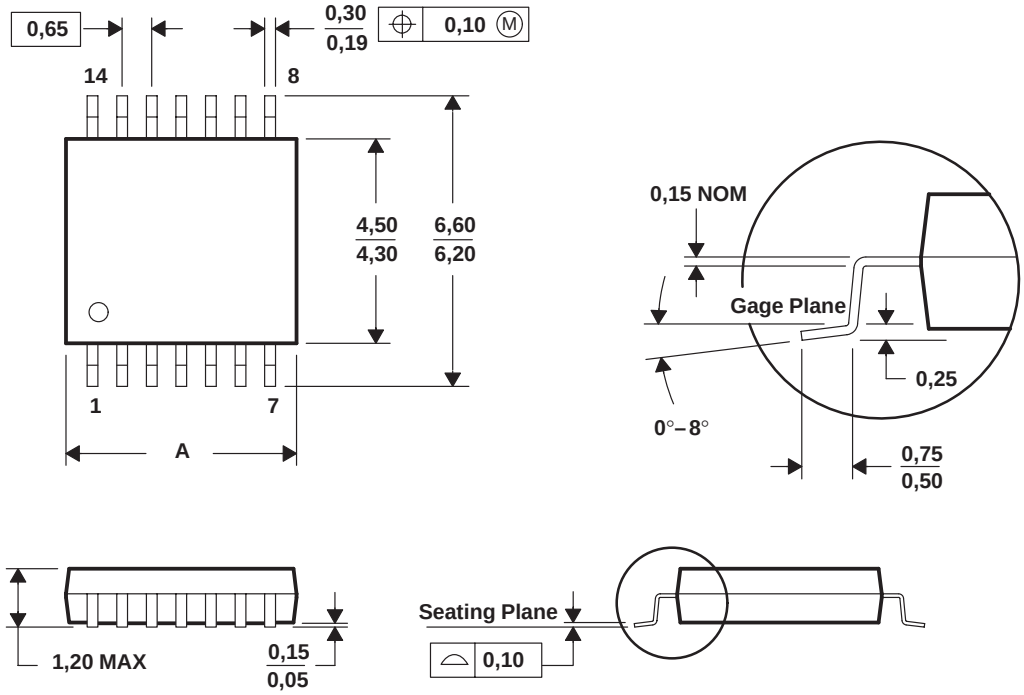
DIM \ PINS **	14	16	20	24	28	30	38
A MAX	6,50	6,50	7,50	8,50	10,50	10,50	12,90
A MIN	5,90	5,90	6,90	7,90	9,90	9,90	12,30

4040065 /E 12/01

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-150

PW (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN



DIM \ PINS **	8	14	16	20	24	28
A MAX	3,10	5,10	5,10	6,60	7,90	9,80
A MIN	2,90	4,90	4,90	6,40	7,70	9,60

4040064/F 01/97

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-153

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